

RD74LVC2G125

Dual Bus Buffer with 3-state Output

REJ03D0753-0100 Rev.1.00 Jul 26, 2006

Description

The RD74LVC2G125 has dual bus buffer with 3–state output in an 8-pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

• The basic gate function is lined up as renesas uni logic series.

• Supply voltage range: 1.65 to 5.5 V

• Operating temperature range: -40 to +85°C

• All inputs: V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V)

• All outputs: V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)

• Output current: $\pm 4 \text{ mA } (@V_{CC} = 1.65 \text{ V})$

 $\pm 8 \text{ mA} (@V_{CC} = 2.3 \text{ V})$

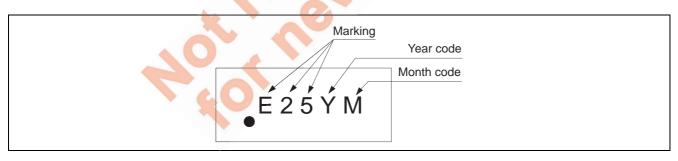
 $\pm 24 \text{ mA } (@V_{CC} = 3.0 \text{ V})$

 $\pm 32 \text{ mA } (@V_{CC} = 4.5 \text{ V})$

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD74LVC2G125WPE	WCSP-8 pin	SXBG0008LA-A (TBS-8BV)	WP	E (3,000 pcs/reel)

Article Indication



Function Table

Inp	Output Y	
ŌĒ	Α	Output 1
L	Н	Н
L	L	L
Н	X	Z

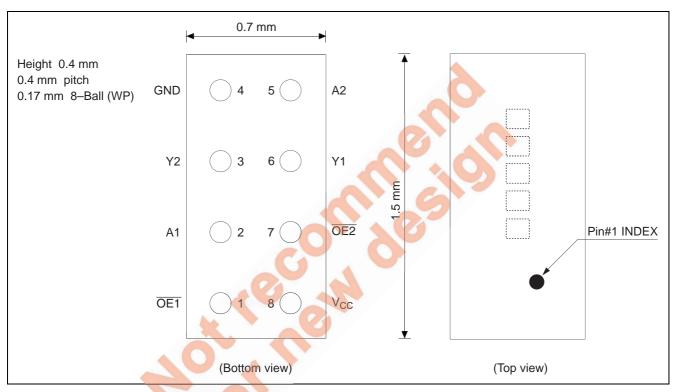
H: High level

L: Low level

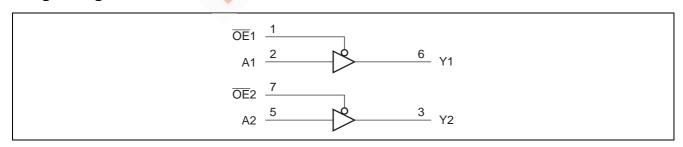
X: Immaterial

Z: High impedance

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 6.5	V	
Input voltage range *1	VI	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V_{CC} +0.5	V	Output: H or L
	v _O	-0.5 to 6.5	v	V _{CC} : OFF or Output "Z"
Input clamp current	I _{IK}	-50	mA	V ₁ < 0
Output clamp current	I _{OK}	-50	mA	V _O < 0
Continuous output current	I ₀	±50	mA	$V_O = 0$ to V_{CC}
Continuous current through	Icc or I _{GND}	±100	mA	
V _{CC} or GND	00 0.15			
Package Thermal impedance	θ_{ja}	140	°C/W	WP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

ltem	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	
			4		V _{CC} = 1.65 V
		-	8		V _{CC} = 2.3 V
	I _{OL}	_	16		V _{CC} = 3.0 V
		-4	24		V _{CC} = 3.0 V
Output ourrant	40	-11	32	mA	V _{CC} = 4.5 V
Output current			-4	IIIA	V _{CC} = 1.65 V
			-8		V _{CC} = 2.3 V
	Іон	_	-16		V _{CC} = 3.0 V
		_	-24		V _{CC} = 3.0 V
		_	-32		V _{CC} = 4.5 V
	40	0	20		$V_{CC} = 1.65 \text{ to } 1.95 \text{ V},$
Input transition rise or fall rate	Δt / Δν	O	20	ns / V	2.3 to 2.7 V
input transition rise or rail fate	Δι / Δν	0	10	115 / V	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	5		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

Ta = -40 to $85^{\circ}C$

Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test condition
		1.65 to 1.95	V _{CC} ×0.65	_	_		
	V _{IH}	2.3 to 2.7	1.7	_	_		
	VIH	3.0 to 3.6	2.0	_	_		
Input voltage		4.5 to 5.5	$V_{CC} \times 0.7$			V	
input voltage		1.65 to 1.95	_	_	V _{CC} ×0.35	V	
	V_{IL}	2.3 to 2.7	_	_	0.7		
	V IL	3.0 to 3.6	_	_	0.8		
		4.5 to 5.5	_	_	V _{CC} ×0.3		
		Min to Max	V _{CC} -0.1	_	_		$I_{OH} = -100 \mu A$
		1.65	1.2	_	_		$I_{OH} = -4 \text{ mA}$
	V _{OH}	2.3	1.9	_	_		$I_{OH} = -8 \text{ mA}$
	VOH	3.0	2.4	_	_		$I_{OH} = -16 \text{ mA}$
		3.0	2.3	_	_		$I_{OH} = -24 \text{ mA}$
Output voltage		4.5	3.8	_		V	$I_{OH} = -32 \text{ mA}$
Output voltage	V_{OL}	Min to Max		_	0.1	V.	l _{OL} = 100 μA
		1.65		_	0.45	100	$I_{OL} = 4 \text{ mA}$
		2.3		_	0.3		I _{OL} = 8 mA
	VOL	3.0		-//	0.4	A	I _{OL} = 16 mA
		3.0		-/	0.55	10	l _{OL} = 24 mA
		4.5			0.55	X	l _{oL} = 32 mA
Input current	I _{IN}	0 to 5.5			±5	μA	$V_{IN} = 5.5 \text{ V or GND}$
Off state Output current	l _{OZ}	5.5	-6	-	10	μΑ	V _O = 5.5 V or GND
Quiescent	Icc	1.65 to 5.5	(4)	_	10	^	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
supply current	Δlcc	3 to 5.5	9_	12	500	μΑ	One input at V _{CC} –0.6 V, Other input at V _{CC} or GND
Output leakage current	I _{OFF}	0	A		±10	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	CIN	3.3		3.5	_	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC}=1.8{\pm}0.15~V$

Item	Cumbal	Ta = -40	to 85°C Unit		Test Conditions	FROM	ТО
	Symbol	Min	Max	Ollit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	2.8	8.0	ns		Α	Υ
Output enable time	t _{ZH}	3.3	9.4	ns	$C_L = 30 \text{ pF}, R_L = 1.0 \text{ k}\Omega$	ŌĒ	Y
Output disable time	t _{HZ}	1.3	9.2	ns		ŌĒ	Υ

 $V_{CC}=2.5{\pm}0.2~V$

Item	Symbol	Symbol Ta = -40 to		Unit	Test Conditions	FROM	ТО
	Syllibol	Min	Max	Ollit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.2	5.5	ns	$C_L = 30 \text{ pF, } R_L = 500 \Omega$	Α	Υ
Output enable time	t _{ZH}	1.5	6.6	ns		ŌĒ	Υ
Output disable time	t _{HZ} t _{LZ}	1.0	5.0	ns		ŌĒ	Υ

 $V_{CC} = 3.3 \pm 0.3 \text{ V}$

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM	то
	Symbol	Min	Max	Onic	rest conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0	4.5	ns	25	Α	Υ
Output enable time	t _{ZH}	1.0	5.3	ns	$C_L = 50 \text{ pF}, R_L = 500 \Omega$	ŌĒ	Υ
Output disable time	t _{HZ}	1.0	5.0	ns		ŌĒ	Υ

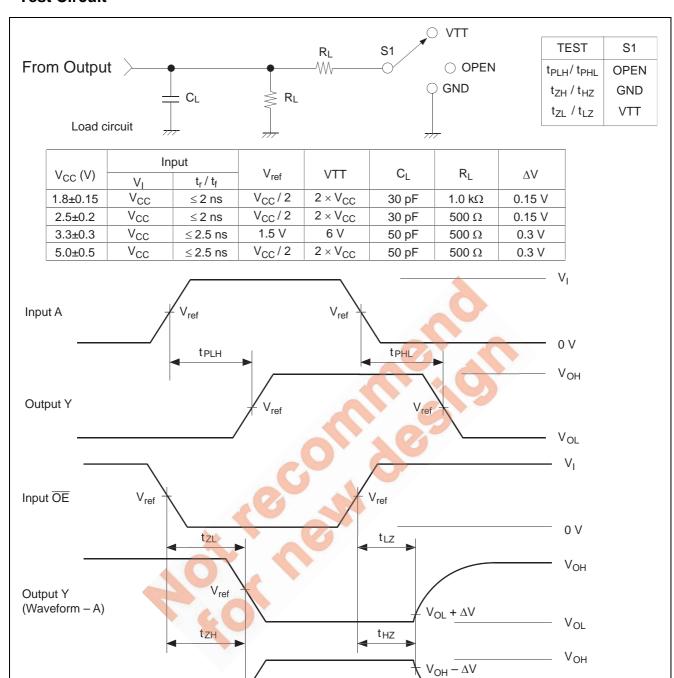
 $V_{CC} = 5.0 \pm 0.5 \text{ V}$

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM	ТО
item	Syllibol	Min	Max	Ollit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	1.0	4.0	ns		Α	Υ
Output enable time	t _{ZH}	1.0	5.0	ns	$C_L = 50 \text{ pF}, R_L = 500 \Omega$	ŌĒ	Υ
Output disable time	t _{HZ}	1.0	4.2	ns		ŌĒ	Υ

Operating Characteristics

Item	Symbol	V _{cc} (V)		Ta = 25°C		Unit	Test Conditions
item	Symbol	VCC (V)	Min	Тур	Max	Oilit	rest conditions
Power dissipation capacitance	C _{PD}	1.8	_	19	_		f = 10 MHz
		2.5	_	19	_	pF	
		3.3	_	20	_		
		5.0		22			

Test Circuit



Notes: 1. C_L includes probe and jig capacitance.

 V_{ref}

2. Waveform—A is for an output with internal conditions such that the output is low except when disabled by the output control.

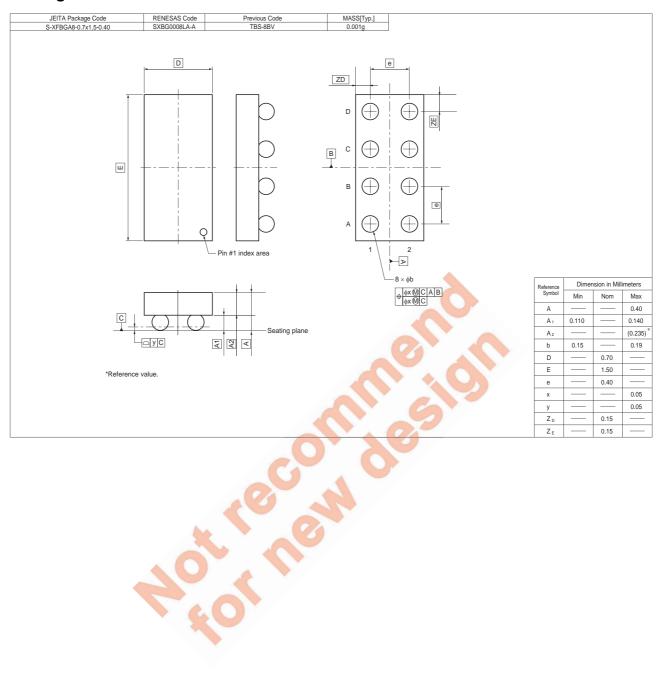
 V_{OL}

- 3. Waveform—B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. All input pulses are supplied by generators having the following characteristics: PRR \leq 10MHz, Zo = 50 $\Omega.$
- 5. The output are measured one at a time with one transition per measurement.

Output Y

(Waveform - B)

Package Dimensions



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